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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/718,466	11/19/2003	Teng-Chun Tsai	JCLA11486	1034
759	09/20/2004		EXAMINER	
J.C. Patents, In Suite 250	ic.		NGUYEN, GEORGE BINH MINH	
4 Venture			ART UNIT	PAPER NUMBER
Irvine, CA 926	518		3723	
			DATE MAILED: 09/20/200	4

Please find below and/or attached an Office communication concerning this application or proceeding.

	T	T				
	Application No.	Applicant(s)				
	10/718,466	TSAI ET AL.				
Office Action Summary	Examiner	Art Unit				
	George Nguyen	3723				
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the	correspondence address				
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply If NO period for reply is specified above, the maximum statutory period v Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be till y within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	nely filed /s will be considered timely. Ithe mailing date of this communication. ED (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on						
	action is non-final.					
3) Since this application is in condition for allowar	, — , — , — , — , — , — , — , — , — , —					
Disposition of Claims						
4) ☐ Claim(s) 1-21 is/are pending in the application. 4a) Of the above claim(s) is/are withdray 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-21 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	wn from consideration.					
Application Papers						
9) ☐ The specification is objected to by the Examine 10) ☑ The drawing(s) filed on 19 November 2003 is/a Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) ☐ The oath or declaration is objected to by the Ex	re: a) \square accepted or b) \square objecting drawing(s) be held in abeyance. Se ion is required if the drawing(s) is obtained.	e 37 CFR 1.85(a). ejected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
a) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority documents application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Applicat rity documents have been receive u (PCT Rule 17.2(a)).	ion No ed in this National Stage				
Attachment(s) 1) X Notice of References Cited (PTO-892)	A) 🔲 Interview Com	(PTO 412)				
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:					

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DETAILED ACTION

This application has been filed with formal drawings which are accepted to the examiner.

Claims 1-21 are presented for examination.

Priority

1. Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

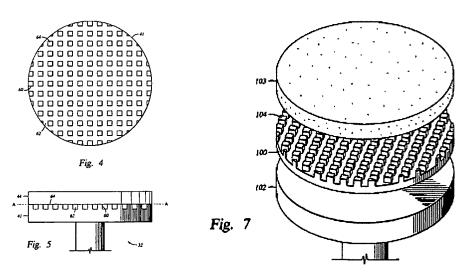
Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claims 1, 2, 6, 8, 11-16 are rejected under 35 U.S.C. 102(b) as being anticipated by Tolles et al.'6,220.942.

With reference to Figures 4, 5, and 7, Tolles discloses the claimed invention.



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US 6,220,942 B1

FIG. 4 shows a preferred embodiment of a platen 41 of the invention. The platen 41 comprises a patterned surface whereon a polishing pad may be disposed. Generally, the patterned surface has features formed therein dellning a patierned surface his features formed increas defining a raised area and a recessed area. In the embodiment shown in FIG. 4, the raised area consists of a plurality of intersecting grooves 62 defined by the prorusions 60. More specifically, the recessed area consists of two parallel sets of equally areas of embournable intersecting consus 62 in a checker. spaced orthogonally intersecting grooves 62 in a checker-board pattern. Each groove 62 traverses the upper surface of the platen 41 from one perimeter to the another. Thus, the grooves 62 are not contained, or blocked, at either end. However, the present invention also contemplates an article of the present invention also contemplates and the present invention also contemplates and the present the embodiment having blocked grooves.

The raised area of the platen 41, or protrusions 60, defines a pad mounting surface. Preferably, the protrusions 60 ecoperate to provide a substantially planar mounting surface 64 slong a common plane A for supporting a polishing pad 44 as shown in FIG. 5. The pad 44 is attached using a 44 as shown in FIG. 5. The pad 44 is attached using a commercially available pressure sensitive adhesive (PSA). 20 Thus, the present invention eliminates the bottom pad of prior art as discussed with reference to FIG. 1. Further, the necessary pad compliance, previously achieved by using a bottom pad, is now provided by the cooperation of the recessed and raised areas, or grooves 62 and protonsions 60, 25 respectively. The protrusions 69 casure sufficient rigidity (or stiffness) while the grooves 62 allow the proper proportion of pad compliance to accommodate a substrate's varying topography.

As noted above, the grooves 62 are preferably open at some point along their length to prevent vacuum adhrence of the pad to the surface. Thus, the grooves 62 provide pathways between the platen 41 and the pad 44 which vent to the environment of the platen 41 as shown in FIG. 5. Such a construction anticipates the use of perforated pack such as those available from Rodel. The perforations in the pad allow fluid flow therethrough. Where the grooves 62 are isolated from the environment, such as where the grooves 6 comprise concentric circles enclosed at the top by a perforsted pad, a partial vacuum condition may be created in the grooves 62 as a substrate is urged against the pad. In such a case, the substrate remains chucked to the pad after the polishing cycle making it difficult to remove. By constructing the grooves 62 as shown in FIGS. 4 and 5, the grooves 62 remain at equal pressure to the ambient environment allowing easy dechucking of the substrate. Where a concention of the substrate of the sub trie pattern is desired, a vent channel or channels extending to the perimeter of the platen 41 can be provided to eliminate adhesion between the substrate and platen 41. Such an embodiment is shown in FIG. 6 and described in detail

Preferably, the protrusions 60 and the grooves 62 shown in FIGS. 4 and 5 are defined by machining away a portion of the upper surface of the platen 41 which comprises a metal such as aluminum. However, the present invention also contemplates alternative embodiments. For example, the plurality of protrusions 60 may be constructed separately from the platen 41. The protrusions 60 may then be secured to the platen 41 surface by conventional methods such as brazing or welding. In another alternative, the place 41 may comprise two separable plates with a lower plate secured to so the motor 46 (shown in FIG. 3) and an upper plate comprising the patterned surface for mounting the pad 44. The plates may be permanently coupled by such methods as velding, or they may be detachably coupled by temporary fasteners or clamps. The latter embodiment provides a versatile platen assembly having an exchangeable mounting

The dimensions of the patterned surface may be varied to schieve the desired proportions of compliance and rigidity. In general, the mounting surface 64 makes up to between about 20 to 95% of the total upper surface area but may be varied according to the pad thickness and modulus, as well as the applied polishing pressure. In a specific embodiment shown in FIG. 4 having a diameter of about twenty (20) inches, the groove depth is about 0.250 inches and the groove width is about 0.052 inches. Thus, the total surface area of the mounting area 64 is preferably about 20–95% of the total area of the platen. The diameter of the platen 41 may be varied to accommedate any substrate size such as may be varied to accommodate any substrate size such as 100 mm, 200 mm or 300 mm substrates. As a result, relative sizes of the grooves and protrusions will vary accordingly.

It is to be understood that the present invention allows for virtually limitless design variations, FIG. 4 and 5 show only one possible embodiment according to the invention.

Another embodiment is shown in FIG. 6. In general, the embodiment of FIG. 6 provides a raised area and recessed area of the platen 41. Specifically, the platen 41 comprises a plurality of "broken" concentric grooves 65 intersected by radial grooves 66. The radial grooves 66 originate at a central hub 67 thereby communicating all of the features of the recessed area. The embodiments described above are merely illustrative and a person skilled in the art will recognize other embodiments within the scope of the present

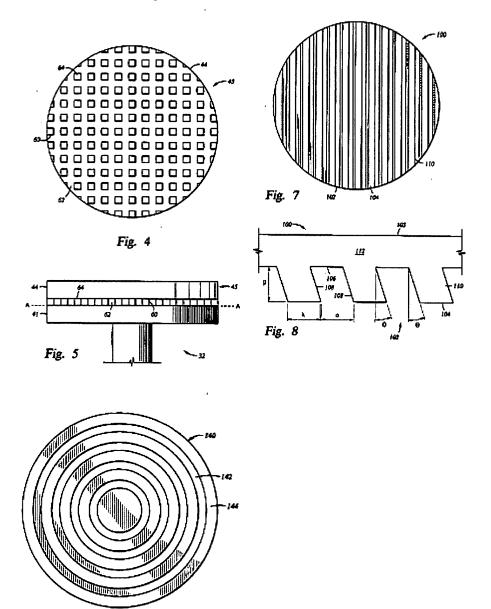
In addition to patterning the upper surface of the platen, a patterned mat, liner or other coating could be applied to or disposed over a typical platen as shown in FIGS. 7 and 8. A hard rubber-like coating could be molded or otherwise formed to provide one of the patterned surfaces described above. Thus, FIG. 7 shows a patterned mat 100 disposed on a platen 102 and having a polishing pad 103 disposed on an upper patterned mounting surface 104. In the specific embodiment shown, the patterned mat 100 has a surface profile similar to that of the platen 41 shown in PIG. 4 and described above, however, any pattern may be used to advantage. In such an embodiment, the platen 102 preferably comprises an untextured mounting surface (as shown in FIG. 7) for securing the patterned mat 100 thereto but may also comprise a patterned surface to cooperate with the patterned mat 100 in providing additional flexibility and compliance. The polishing pad 103, patterned mat 100, and platen 102 are secured to one another by any conventional methods such as by an adhesive.

FIG. 8 is a partial cross sectional view of an alternative embodiment comprising a conting 110 disposed on a pat-terned platen 112. The particular surface profile of the platen 112 shown in FIG. 8 is similar to that of the platen 41 shown in FIG. 4 but it is to be understood that any pattern may be used to advantage, such as those shown in FIGS. 4-7. The coating 110 may be secured to the platen 112 by conventional methods such as by an adhesive. A polishing pad (not shown) may then be secured to the upper mounting surface 114 defined by the coating 110 and platen 112.

The material used for the patterned mat 100 and coating 110 is preferably determined according to the material of the platen. In general, the patterned mat 100 and coating 110 comprise a material more compliant than the platen. For example, where the platen is made of a metal, such as aluminum or stainless steel, the patterned mat 100 and coating 110 may comprise an elastomer such as rubber. Other materials which are known and unknown could be used to advantage.

It is to be understood that terms such as top, bottom, below, above, backside and the like are relative terms and 4. Claims 18-20 are rejected under 35 U.S.C. 102(b) as being anticipated by Tolles et al.'6,217,426.

With reference to Figures 4, 5, 7, 9, and 11, Tolles discloses the claimed invention.



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Claim Rejections - 35 USC § 103

- 5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 6. Claims 3-5, 7, 9-10, 17, and 21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tolles et al.'942 in view of Wang'6,666,751 and Tolles et al.'426. Tolles et al.'942 has been discussed above, but does not disclose that both surfaces of the sub-polishing pad are undulating.

With reference to Figure 10, Wang discloses that the sub-polishing pad 95 having undulating interfacing surface 101 with the polishing platen 88. The advantage is to significantly enhance the polishing uniformity of the CMP process and substantially reduces any edge effects.

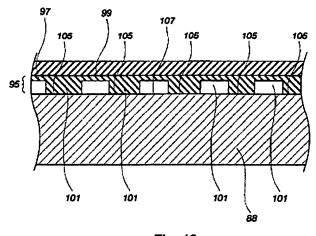


Fig. 10

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Thus, it would have been obvious to one having ordinary skill in the art at the time the invention was made to have modified the sub-polishing pad of Tolles with platen interfacing surface having undulating surface as taught by Wang in order to significantly enhance the polishing uniformity of the CMP process and substantially reduces any edge effects.

Regarding to claim 5, 10, 21, it would have been obvious to one having ordinary skill in the art at the time the invention was made to have utilized fixed abrasive, since it had been held to be within the general skill of a worker in the art to select a known material on the basis of it suitability for the intended use as a matter of obvious design choice. Regarding to claims 3, 9, 13, 16, it would have been obvious to one having ordinary skill in the art at the time the invention was made to have modified the undulating surface of Tolles'942 with different groove configuration as taught by Tolles'426 in order to significantly enhance the polishing uniformity.

Conclusion

7. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Nakata et al.'989, Breivogel et al.'910, Yamamoto'317, Yu'699, Tolles et al.'825 all disclose polishing pad with with undulating surface.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to George Nguyen whose telephone number is 703-308-0163. The examiner can normally be reached on Monday-Friday/630AM-300PM.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Joseph Hail can be reached on 703-308-2687. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

George Nguyen Primary Examiner Art Unit 3723 Page 7

GN - September 15, 2004

GEORGE NGUYEN

PRIMARY EXAMINER